

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

SSM3K05FU

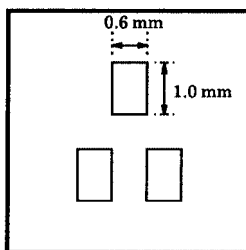
High Speed Switching Applications

- Small package
- Low on resistance: $R_{on} = 0.8 \Omega$ max (@ $V_{GS} = 4 V$)
: $R_{on} = 1.2 \Omega$ max (@ $V_{GS} = 2.5 V$)
- Low gate threshold voltage

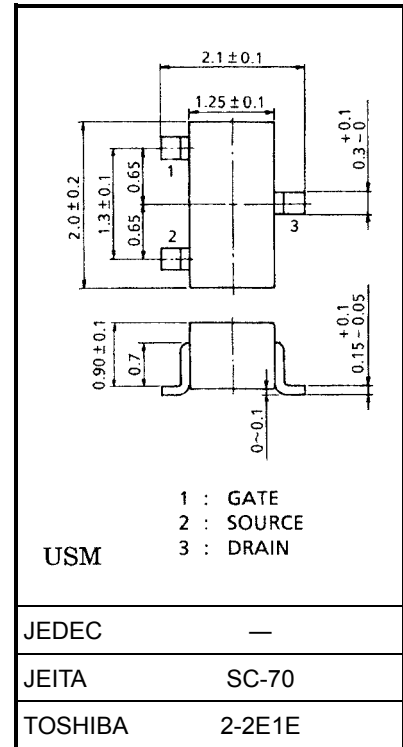
Maximum Ratings ($T_a = 25^\circ C$)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DS}	20	V
Gate-source voltage		V_{GSS}	± 12	V
Drain current	DC	I_D	400	mA
	Pulse	I_{DP}	800	
Drain power dissipation ($T_a = 25^\circ C$)		P_D (Note 1)	150	mW
Channel temperature		T_{ch}	150	$^\circ C$
Storage temperature range		T_{stg}	$-55 \sim 150$	$^\circ C$

Note 1: Mounted on FR4 board.
($25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}$, Cu pad: $0.6 \text{ mm}^2 \times 3$)

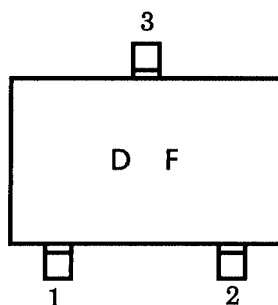


Unit: mm

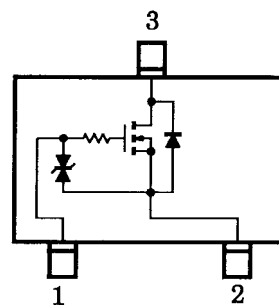


Weight: 0.006 g (typ.)

Marking



Equivalent Circuit



Handling Precaution

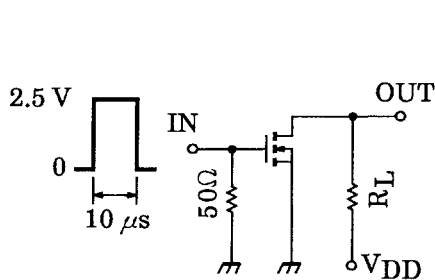
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Electrical Characteristics (Ta = 25°C)

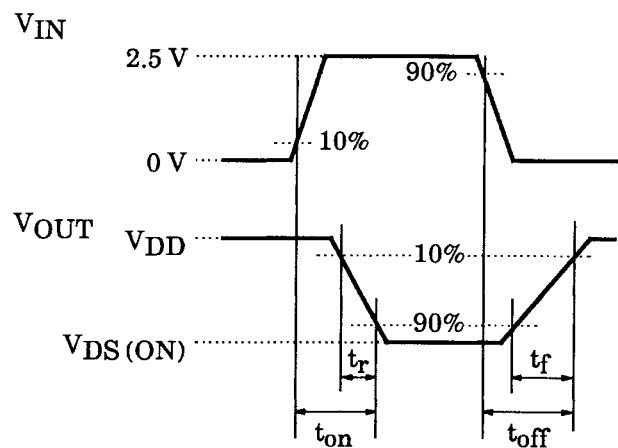
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$	—	—	± 1	μA
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 1 \text{ mA}, V_{GS} = 0$	20	—	—	V
Drain cut-off current	I_{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0$	—	—	1	μA
Gate threshold voltage	V_{th}	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.6	—	1.1	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 3 \text{ V}, I_D = 200 \text{ mA}$ (Note 2)	350	—	—	mS
Drain-source ON resistance	$R_{DS(ON)}$	$I_D = 200 \text{ mA}, V_{GS} = 4 \text{ V}$ (Note 2)	—	0.6	0.8	Ω
		$I_D = 200 \text{ mA}, V_{GS} = 2.5 \text{ V}$ (Note 2)	—	0.85	1.2	
Input capacitance	C_{iss}	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	22	—	pF
Reverse transfer capacitance	C_{rss}	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	9	—	pF
Output capacitance	C_{oss}	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	—	21	—	pF
Switching time	Turn-on time	$V_{DD} = 3 \text{ V}, I_D = 100 \text{ mA},$ $V_{GS} = 0 \sim 2.5 \text{ V}$	—	60	—	ns
	Turn-off time		—	70	—	

Note 2: Pulse test

Switching Time Test Circuit



$V_{DD} = 3 \text{ V}$
 $\text{D.U.} \leq 1\%$
 $V_{IN} : t_r, t_f < 5 \text{ ns}$
 $(Z_{OUT} = 50 \Omega)$
COMMON SOURCE
 $T_a = 25^\circ\text{C}$



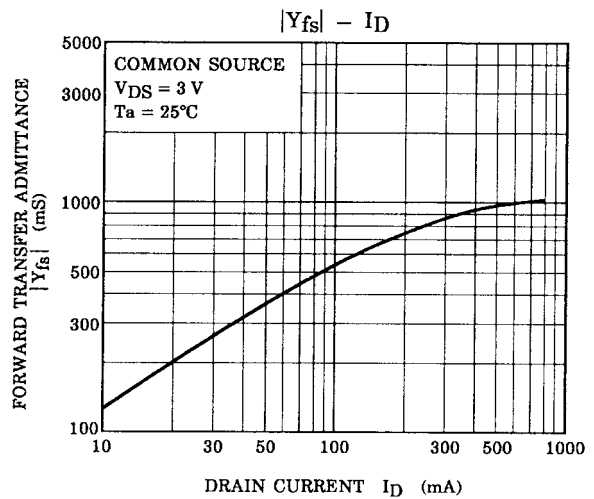
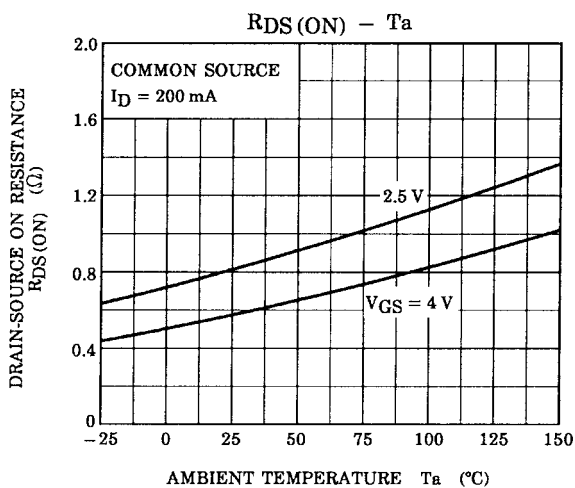
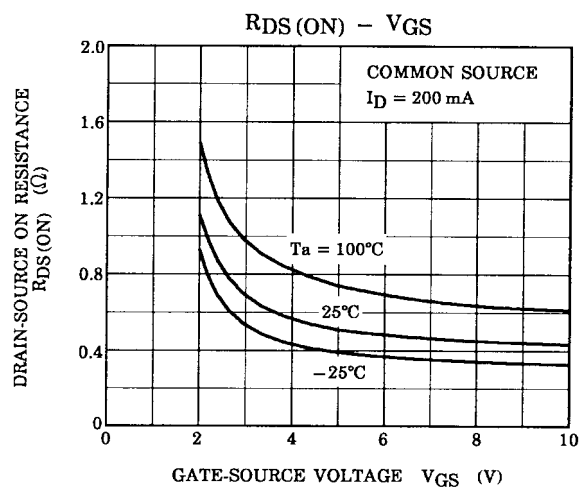
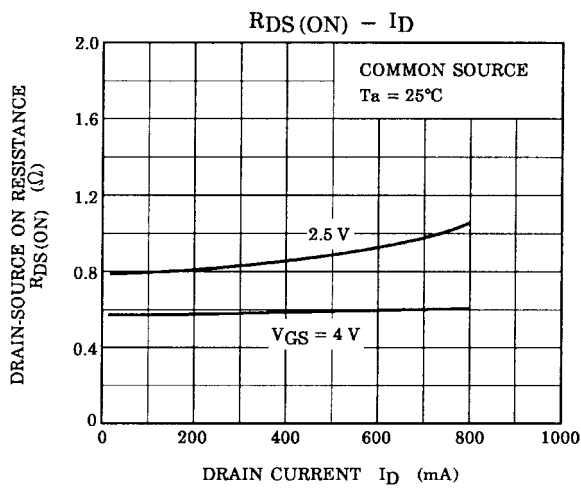
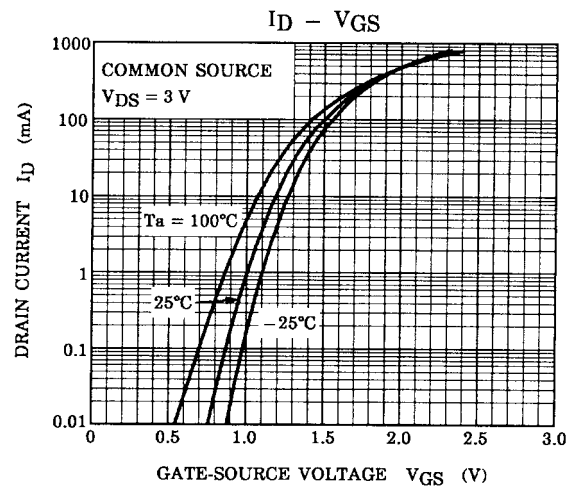
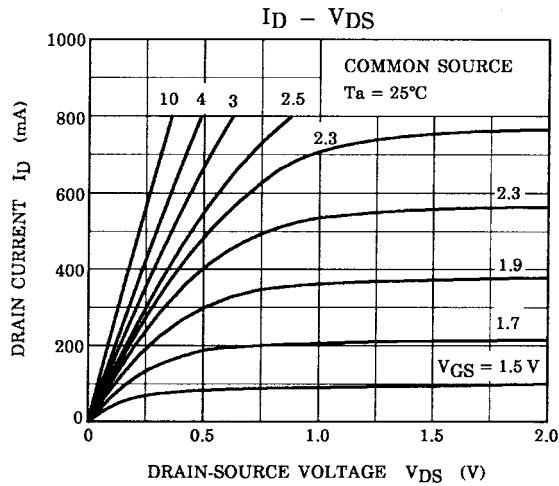
Precaution

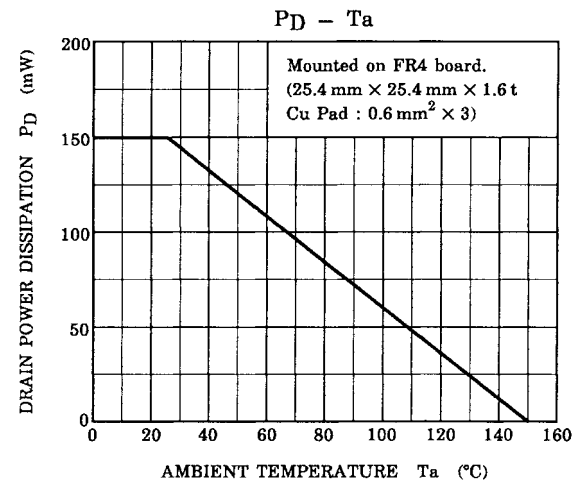
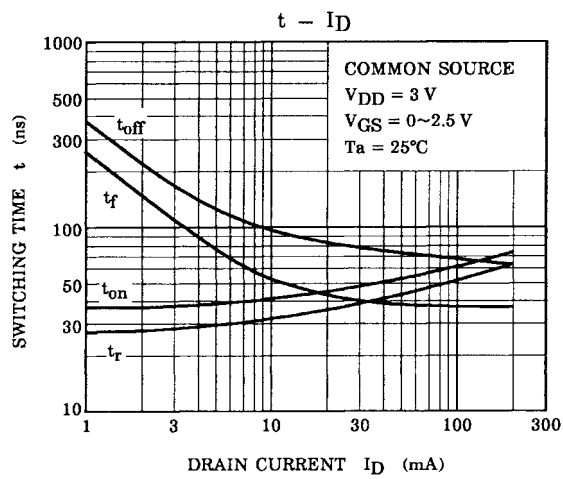
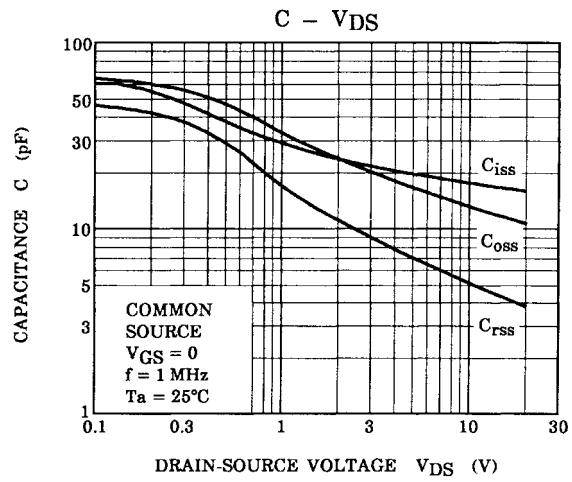
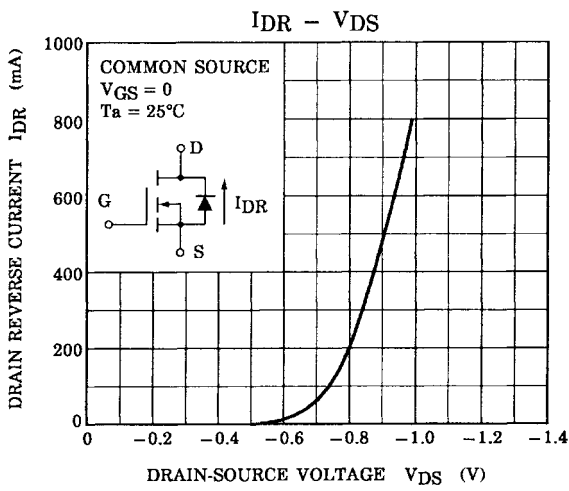
V_{th} can be expressed as voltage between gate and source when low operating current value is $I_D = 100 \mu\text{A}$ for this product. For normal switching operation, $V_{GS(ON)}$ requires higher voltage than V_{th} and $V_{GS(OFF)}$ requires lower voltage than V_{th} .

(Relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$)

Please take this into consideration for using the device.

VGS recommended voltage of 2.5 V or higher to turn on this product.





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